IPC ASSOCIATION ELECTRONICS	© Copyright 20	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under bointernational and Pan-American copyright conventions.		der both This docum level parts,	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					ials and Mfg Information			
upplier	Information													
Company name*				Company unique ID			Unique ID Authority				Response Date*			
nsemi							I				2023-06-08			
Contact Na	me		Title - Contact			Phone - Contact*				Email -	Email - Contact*			
Product-E	nv-Stewards		Product Enviro Compliance			NA				Produc	Product-Env-Stewards@onsemi.com			
uthorized	Representative*		Title - Representative			Phone - Representative*			Email -	Email - Representative*				
Product-E	nv-Stewards		Product Enviro Compliance			NA				Produc	Product-Env-Stewards@onsemi.com			
	Requester Item Number	Mfr Iten	n Number	Mfr Item Name		Effective D	ate Vers	on Manufacturing Site			Weight*	UOM	Unit Type	
		NB3V83	312CMNG	Low Skew 1 to 12 Buffer	LVCMOS/LVTTL Fanout	2023-06-08					74.3	mg	Each	
	turing Proccess Info													
	2 2			Terminal Base Alloy J-STD-020 MSL Ra				ure Max Time at Peal	k Tempera	ture Num	ber of Reflow Cyc	eles		
N	Matte Tin (Sn) - annealed	l (	CU Alloy	1		260		C	30	secor	nds 3			
omments														
vel 1 - ma	ximum time at peak temp	perature during so	ldering is 10-3	0 seconds										
or more in	nformation regarding ma	terial composition	please refer to	page 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	ed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its uppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided in formation the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms andConditions of Sale applicable to such part shall apply.										
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the					

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

<b>Homogeneous Material</b>	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.67	mg	Supplier	Silicon (Si)	7440-21-3		1.67	mg
Die Attach	0.37	mg	Supplier	Isobornyl Methacrylate	7534-94-3		0.0222	mg
			Supplier	Silver (Ag)	7440-22-4		0.3016	mg
			Supplier	Isobornyl Acrylate	5888-33-5		0.0222	mg
			Supplier	Misc.	Proprietary Data		0.0019	mg
			Supplier	Tricyclo[5.2.1.02,6]decanedimethanol Diacrylate (C18H24O4)	42594-17-2		0.0222	mg
Lead Frame	33.6	mg	Supplier	Silver (Ag)	7440-22-4		0.336	mg
			Supplier	Tin (Sn)	7440-31-5		0.084	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0739	mg
			Supplier	Chromium (Cr)	7440-47-3		0.084	mg
			Supplier	Copper (Cu)	7440-50-8		33.0221	mg
Mold Compound-Black	37.0	mg		Epoxy resin	proprietary data		1.739	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		3.7	mg
			Supplier	Carbon Black (C)	1333-86-4		0.037	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		29.785	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1.739	mg
Plating	1.3	mg	Supplier	Tin (Sn)	7440-31-5		1.3	mg
Wire Bond - Au	0.36	mg	Supplier	Gold (Au)	7440-57-5		0.36	mg